

STPS2045C-Y

Automotive power Schottky rectifier

Features

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Avalanche rated
- AEC-Q101 qualified

Description

Dual center tap Schottky rectifier suited for high frequency DC to DC converters.

Packaged in D²PAK, this device is especially intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.

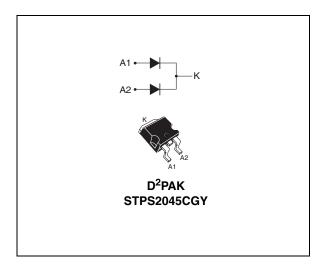


Table 1. Device summary

| I _{F(AV)} | 2 x 10 A |
|---------------------|----------|
| V _{RRM} | 45 V |
| T _{j(max)} | 175 °C |
| V _{F(typ)} | 0.57 V |

Characteristics STPS2045C-Y

Characteristics 1

Table 2. Absolute ratings (limiting values, per diode)

| Symbol | Parameter | Value | Unit | | |
|---------------------|---|-----------------------------------|---------|-------------|------|
| V _{RRM} | Repetitive peak reverse voltage | | | 45 | V |
| I _{F(RMS)} | Forward rms current | | | 30 | Α |
| I _{F(AV)} | Average forward current $\delta = 0.5$ | T _c = 155 °C Per diode | | 10 | Α |
| I _{FSM} | Surge non repetitive forward current | $t_p = 10 \text{ ms sin}$ | usoidal | 180 | Α |
| P _{ARM} | Repetitive peak avalanche power $t_p = 1 \mu s$, $T_j = 25 °C$ | | | 4000 | W |
| T _{stg} | Storage temperature range | | | -65 to +175 | °C |
| T _j | Maximum operating junction temperature ⁽¹⁾ | | | -40 to +175 | °C |
| dV/dt | Critical rate of rise of reverse voltage | | | 10000 | V/µs |

 $[\]frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances parameters

| Symbol | Parameter | Value | Unit | |
|----------------------|------------------|--------------------|------------|------|
| R _{th(j-c)} | Junction to case | Per diode Total | 2.2 1.3 | °C/W |
| R _{th(c)} | Coupling | | 0.3 | °C/W |

When the diodes 1 and 2 are used simultaneously:

 $T_j(diode\ 1) = P(diode\ 1)\ x\ R_{th(j-c)}(per\ diode) + P(diode\ 2)\ x\ R_{th(c)}$

Table 4. Static electrical characteristics (per diode)

| Symbol | Test conditions | | | Min. | Тур. | Max. | Unit |
|---|---|-------------------------|-----------------------|------|------|------|------|
| I _B ⁽¹⁾ | I _B ⁽¹⁾ Reverse leakage current | | V - V | - | - | 100 | μΑ |
| 'R` | IR. A Heverse leakage current | T _j = 125 °C | $V_R = V_{RRM}$ | - | 7 | 15 | mA |
| | | T _j = 125 °C | I _F = 10 A | - | 0.5 | 0.57 | |
| V _F ⁽¹⁾ Forward voltage | Forward voltage drop | T _j = 25 °C | I _F = 20 A | - | - | 0.84 | V |
| | | T _j = 125 °C | 7 1F = 20 A | - | 0.65 | 0.72 | |

^{1.} Pulse test : t_p = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.42 x $I_{F(AV)}$ + 0.015 $I_{F}^{2}_{(RMS)}$

$$P = 0.42 \times I_{F(AV)} + 0.015 I_{F}^{2}_{(RMS)}$$

STPS2045C-Y Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus awerage forward current ambient temperature (per diode) (δ = 0.5, per diode)

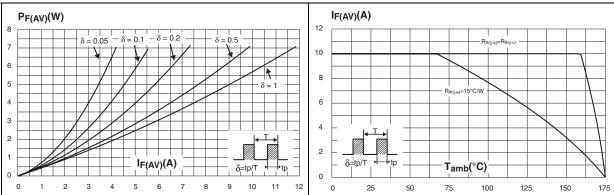


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

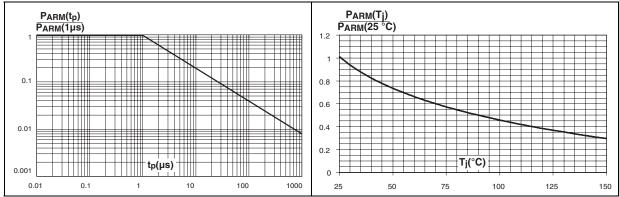
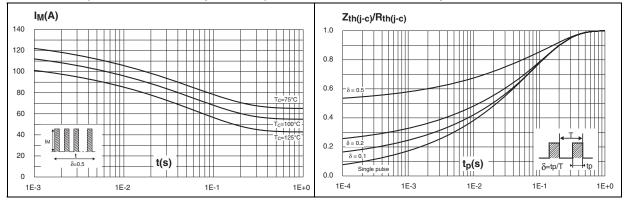


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values, per diode)

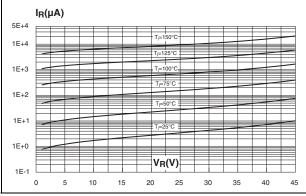
Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values, per diode)

Figure 8. Junction capacitance versus reverse voltage applied (typical values, per diode)



C(pF)

1000

F=1MHz
Vosc=30mVenss
Tp=25°C

100

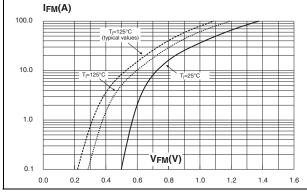
VR(V)

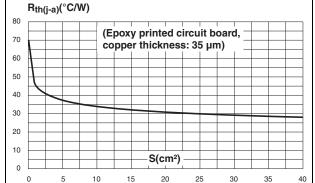
100

1 2 5 10 20 50

Figure 9. Forward voltage drop versus forward current (maximum values, per diode)

Figure 10. Thermal resistance junction to ambient versus copper surface under tab





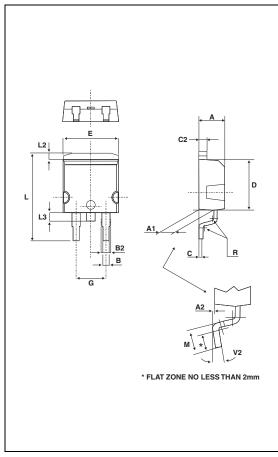
4/7 Doc ID 17262 Rev 1

2 Package information

- Epoxy meets UL94, V0
- Lead-free package

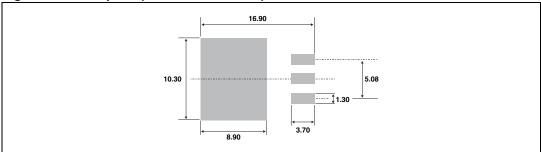
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 5. D²PAK dimensions



| | | nsions | | |
|------|-------------|--------|------------|-------|
| Ref. | Millimeters | | Inc | hes |
| | Min. | Max. | Min. | Max. |
| Α | 4.40 | 4.60 | 0.173 | 0.181 |
| A1 | 2.49 | 2.69 | 0.098 | 0.106 |
| A2 | 0.03 | 0.23 | 0.001 | 0.009 |
| В | 0.70 | 0.93 | 0.027 | 0.037 |
| B2 | 1.14 | 1.70 | 0.045 | 0.067 |
| С | 0.45 | 0.60 | 0.017 | 0.024 |
| C2 | 1.23 | 1.36 | 0.048 | 0.054 |
| D | 8.95 | 9.35 | 0.352 | 0.368 |
| Е | 10.00 | 10.40 | 0.393 | 0.409 |
| G | 4.88 | 5.28 | 0.192 | 0.208 |
| L | 15.00 | 15.85 | 0.590 | 0.624 |
| L2 | 1.27 | 1.40 | 0.050 | 0.055 |
| L3 | 1.40 | 1.75 | 0.055 | 0.069 |
| М | 2.40 | 3.20 | 0.094 | 0.126 |
| R | 0.40 typ. | | 0.016 typ. | |
| V2 | 0° | 8° | 0° | 8° |

Figure 11. Footprint (dimensions in mm)



Ordering information STPS2045C-Y

3 Ordering information

Table 6. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|----------------|-------------|--------------------|--------|----------|---------------|
| STPS2045CGY-TR | STPS2045CGY | D ² PAK | 1.48 g | 1000 | Tape and reel |

4 Revision history

Table 7. Document revision history

| Date | Revision | Changes |
|-------------|----------|------------------|
| 24-May-2011 | 1 | Initial release. |

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